

30V N-Channel Enhancement Mode MOSFET

Description

The NP4406SR uses trench MOSFET technology that is uniquely optimized to provide the most efficient high frequency switching performance. Conduction and switching losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and C_{rss} .

General Features

- ◆ $V_{DS} = 30V$, $I_D = 13A$
 $R_{DS(ON)}(Typ.) = 8m\Omega$ @ $V_{GS} = 10V$
 $R_{DS(ON)}(Typ.) = 11m\Omega$ @ $V_{GS} = 4.5V$
- ◆ Lead free product is acquired
- ◆ Surface mount package

Application

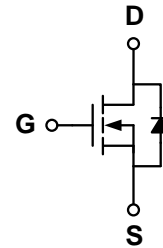
- ◆ High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- ◆ Networking DC-DC Power System
- ◆ Load switch

Package

- ◆ SOP-8

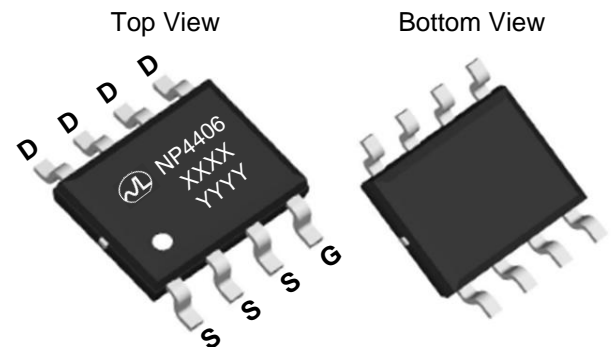


Schematic diagram



Marking and pin assignment

SOP-8



XXXX—Wafer Information
 YYYY—Quality Code

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
NP4406SR-G	-55°C to +150°C	SOP-8	4000

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	V_{DS}	30	V
Gate-source voltage	V_{GS}	±20	V
Continuous Drain Current	I_D	TC=25°C	13
		TC=70°C	10
Pulsed Drain Current	I_{DP}	40	A
Avalanche energy(L=0.1mH)	E_{AS}	50	mJ
Power Dissipation	P_D	TC=25°C	3
		TC=70°C	2.1
Operating junction Temperature range	T_j	-55—150	°C

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	30	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =30V, V _{GS} =0V	-	-	1	μA
		T _J =85°C	-	-	5	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.8	1.6	2.2	V
Drain-source on-state resistance ¹	R _{DS(ON)}	V _{GS} =10V, I _D =13A	-	8	11.5	mΩ
		V _{GS} =4.5V, I _D =10A	-	11	15.5	
On Status Drain Current	I _{D(ON)}	V _{DS} =10V, V _{GS} =5V	40	-	-	A
Diode Characteristics						
Diode Forward Voltage	V _{SD}	I _{SD} =1A, V _{GS} =0V	-	0.82	1.1	V
Diode Continuous Forward Current	I _S		-	-	4	A
Reverse Recovery Time	t _{rr}	I _F =15A,	-	28	-	ns
Reverse Recovery Charge	Q _{rr}	dI/dt=100A/μs	-	40	-	nC
Dynamic Characteristics						
Gate Resistance	R _G	V _{GS} =0V, V _{DS} =0V, f=1MHz	-	2.2	-	Ω
Input capacitance	C _{ISS}	V _{GS} =0V, V _{DS} =15V f=1.0MHz	-	847	-	pF
Output capacitance	C _{OSS}		-	122	-	
Reverse transfer capacitance	C _{RSS}		-	85	-	
Turn-on delay time	t _{D(ON)}	V _{GS} =10V, V _{DS} =15V, R _L =1Ω, R _G =3Ω	-	4.4	-	ns
Turn-on Rise time	t _r		-	9	-	
Turn-off delay time	t _{D(OFF)}		-	17	-	
Turn-off Fall time	t _f		-	6	-	
Total gate charge	Q _g	V _{GS} =10V, V _{DS} =15V, I _D =13A	-	15.5	-	nC
Gate-source charge	Q _{gs}		-	2.7	-	
Gate-drain charge	Q _{gd}		-	2.8	-	

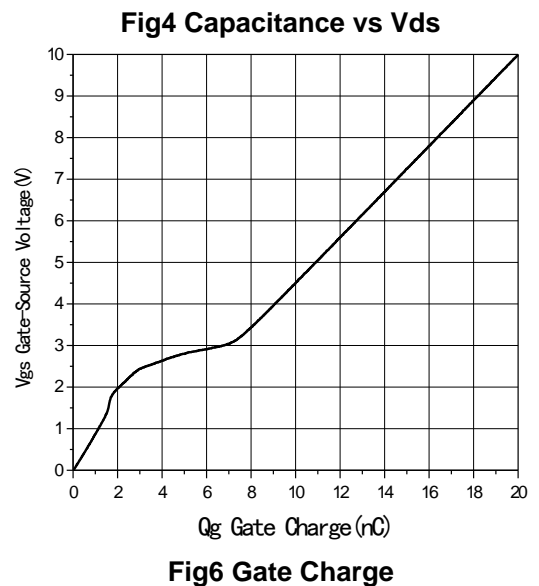
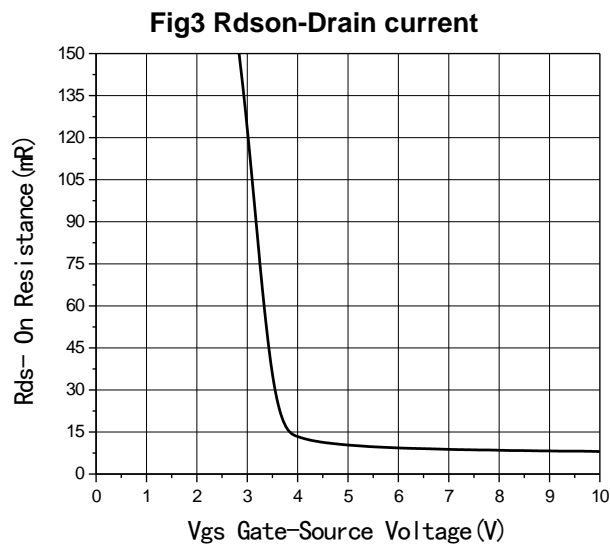
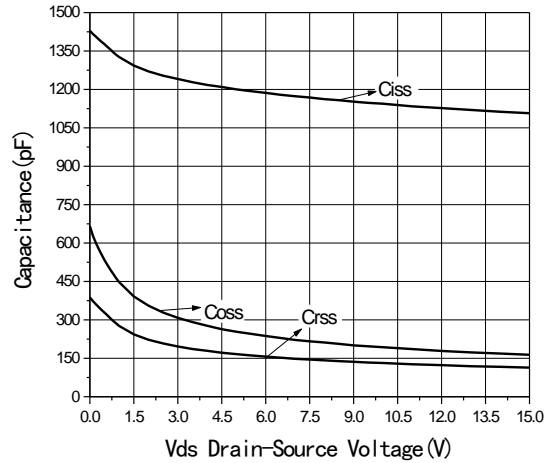
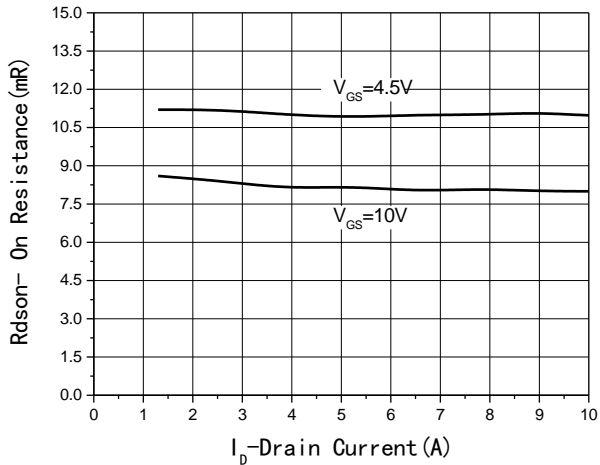
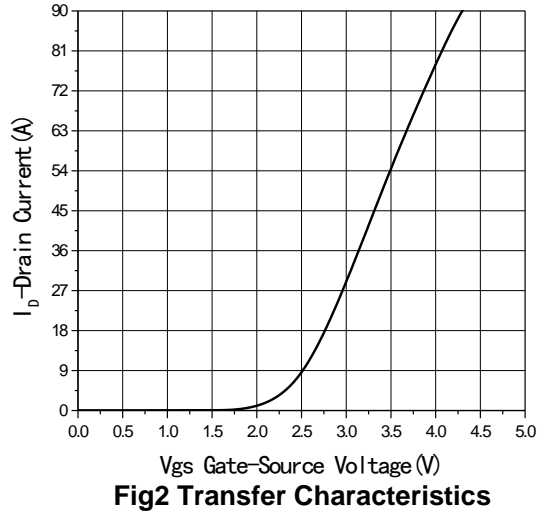
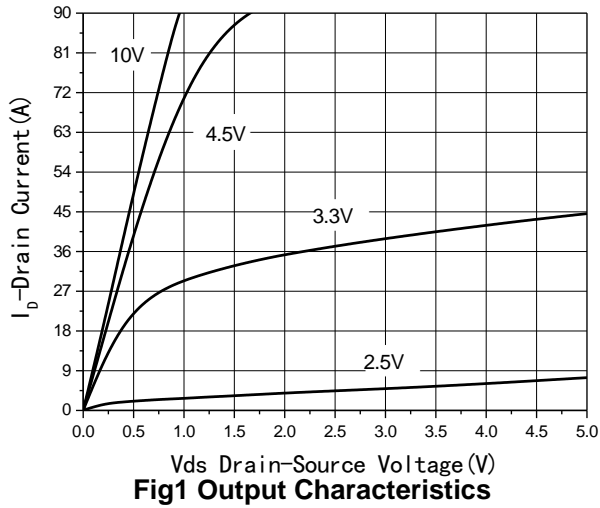
Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Maximum Junction-to-Ambient ^A	R _{θJA}	33	40	°C/W
Maximum Junction-to-Ambient ^A		Steady-State	59	
Maximum Junction-to-Lead ^B	R _{θJC}	16	24	

A: The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJC} and lead to ambient.

Typical Performance Characteristics



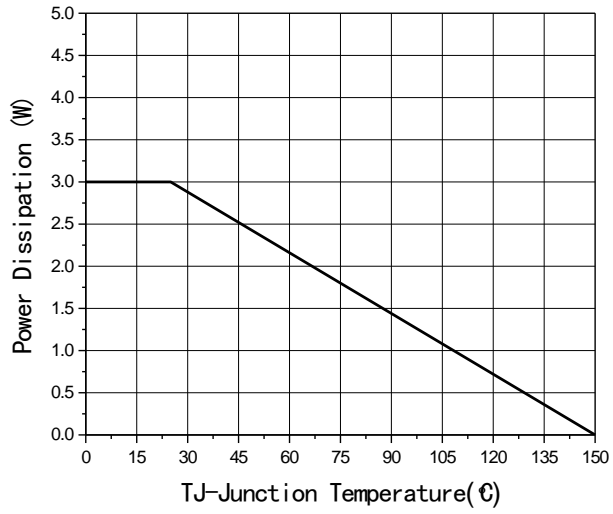


Fig7 Power De-rating

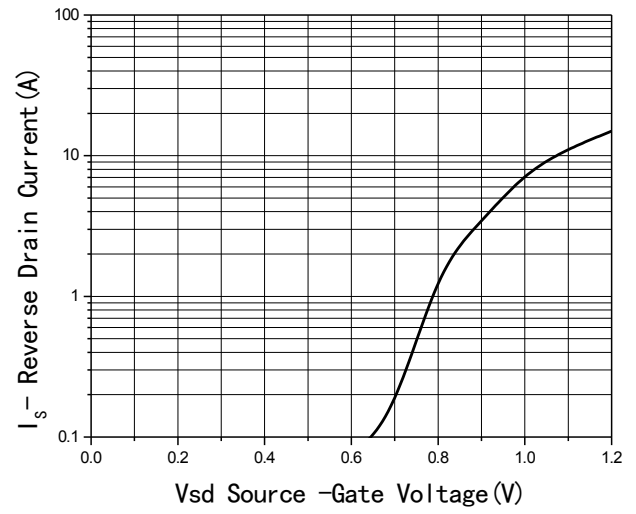
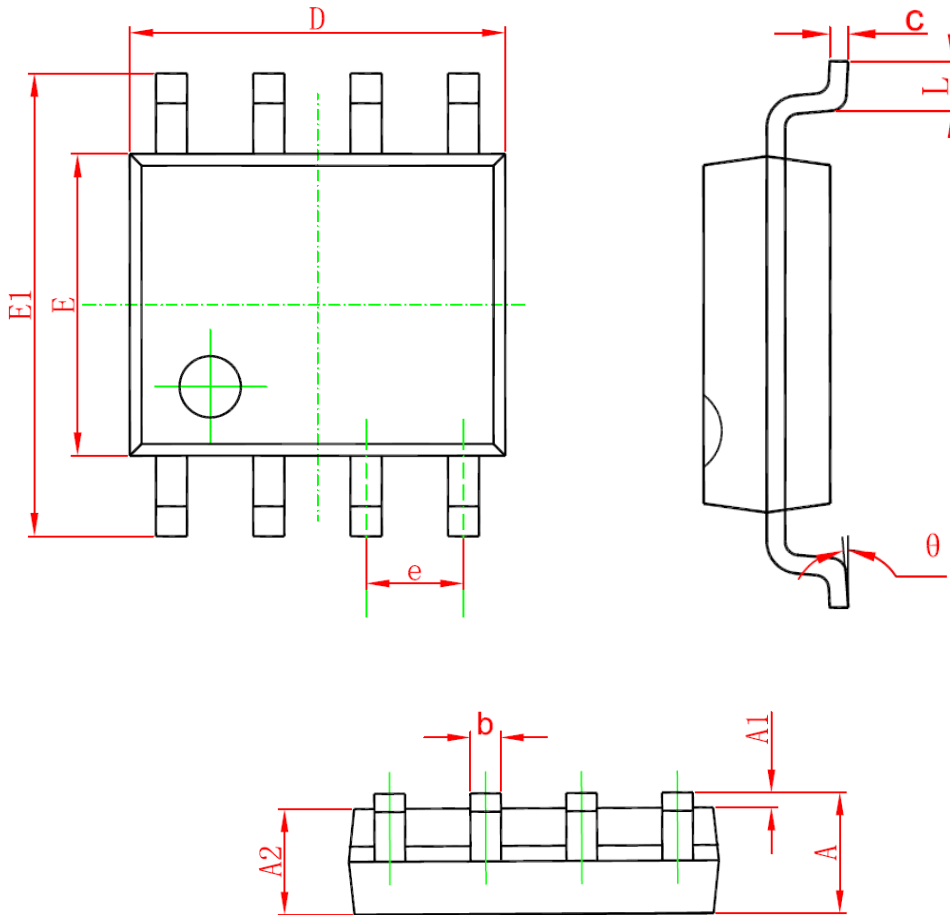


Fig8 Source-Drain Diode Forward

Package Information

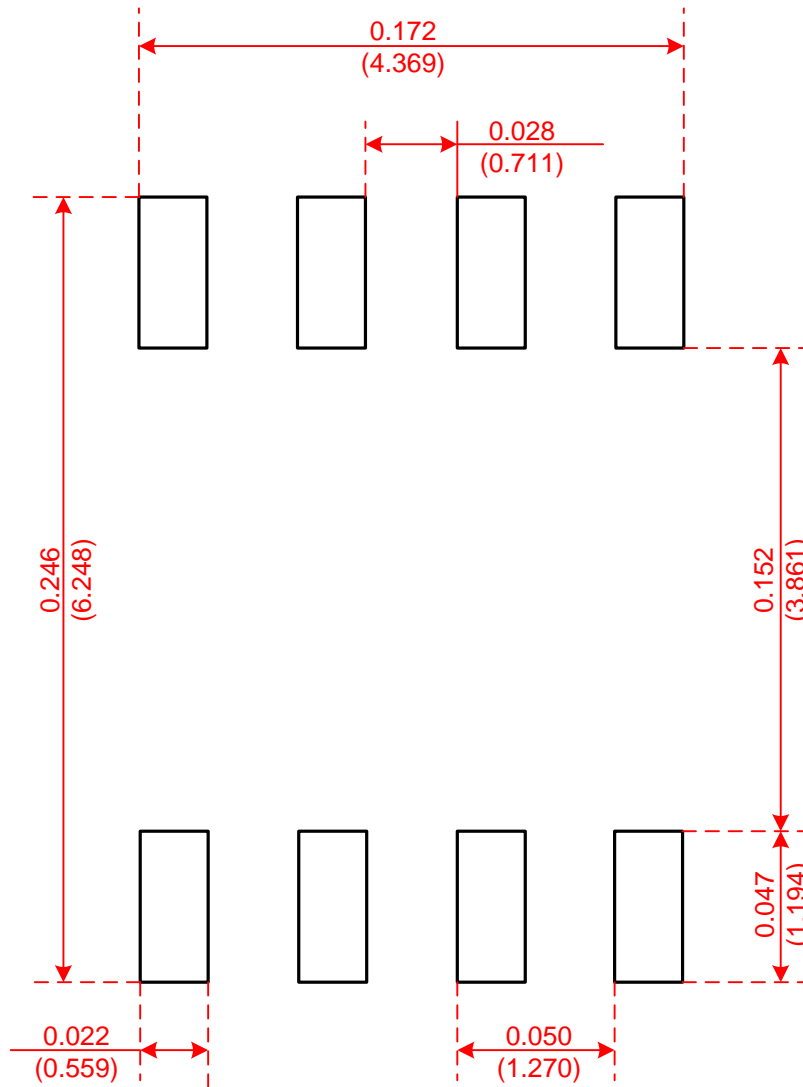
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Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Recommended Minimum Pads

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Recommended Minimum Pads
Dimensions in Inches/(mm)